

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

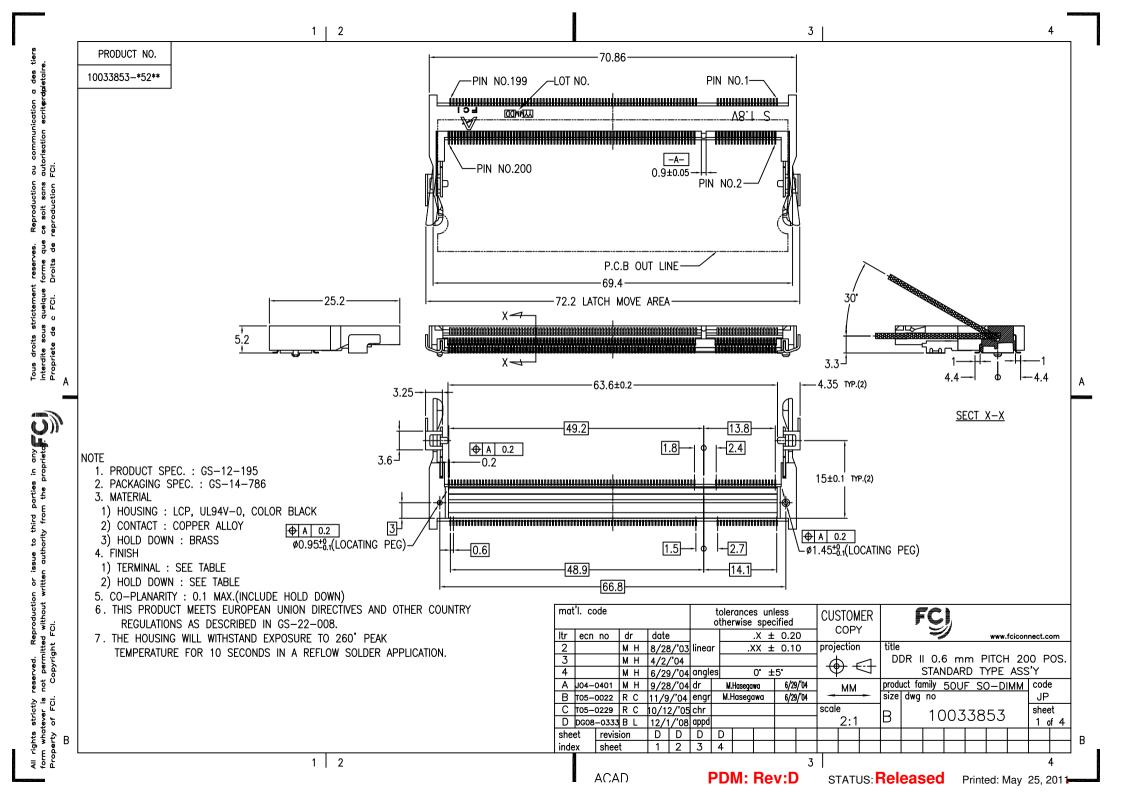
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

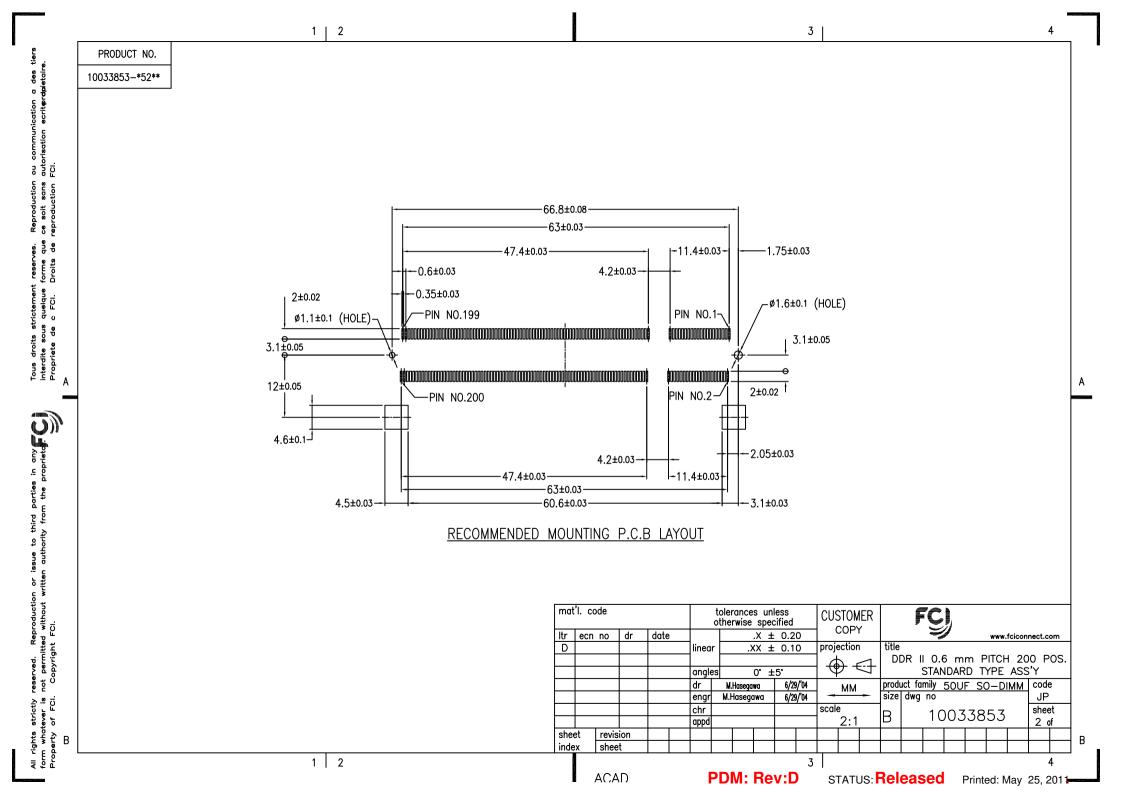
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

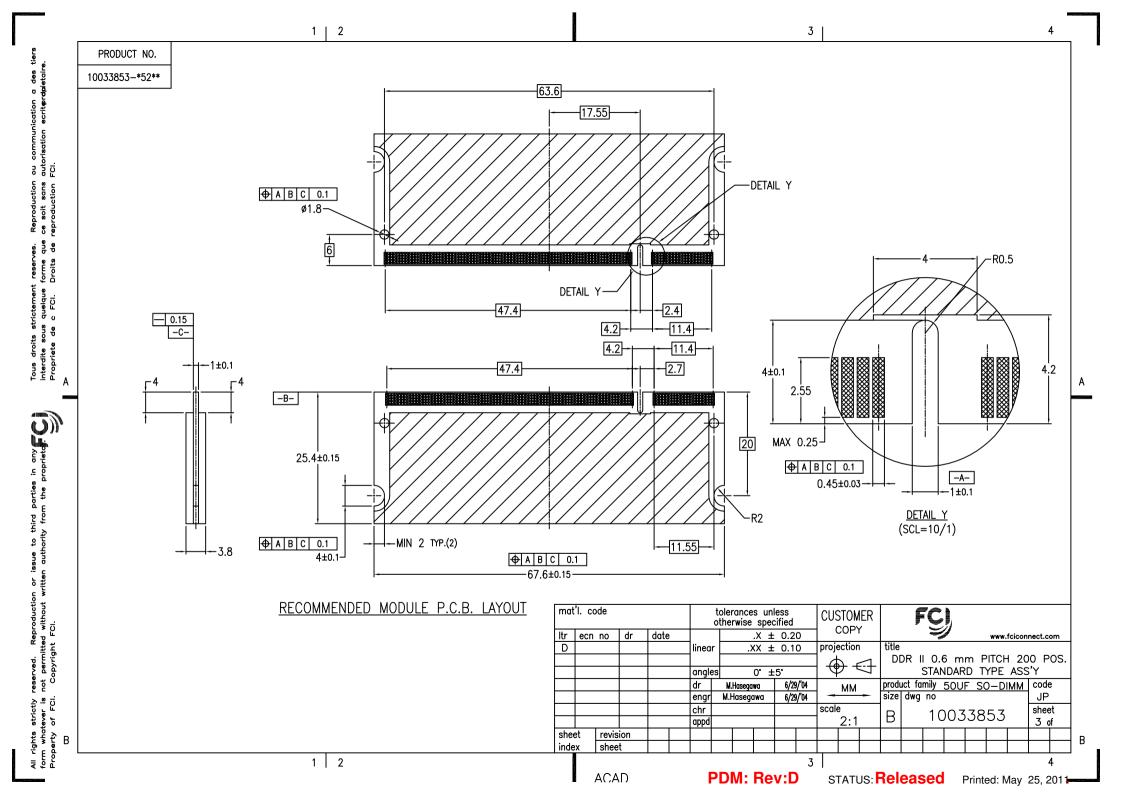












PRODUCT NO.	LOCATING PEG	TERMINAL CONTACT AREA FINISH	HOLD DOWN FINISH	Solder Tail Finish
10033853-052FSLF	YES	Au FLASH	PURE Sn PLATING	- Au FLASH
10033853-152FSLF	NO			
10033853-052TSLF	YES	Au 0.3um MIN.		
10033853-152TSLF	NO			
10033853-052ASLF	YES	Au 0.76um MIN.		
10033853-152ASLF	NO			
10033853-052FB	YES	Au FLASH	Sn-Pb PLATING	
10033853-152FB	NO			
10033853-052TB	YES	Au 0.3um MIN.		
10033853-152TB	NO			
10033853-052AB	YES	Au 0.76um MIN.		
10033853-152AB	NO NO	Au 0.76um Min.		
10033853-252FSLF	YES	Au FLASH	PURE Sn PLATING	Pure Sn PLATING
10033853-352FSLF	NO			
10033853-252TSLF	YES	Au 0.3um MIN.		
10033853-352TSLF	NO			
10033853-252ASLF	YES	Au 0.76um MIN.		
10033853-352ASLF	NO			
10033853-252FB	YES	Au FLASH	Sn—Pb Plating	
10033853-352FB	NO			
10033853-252TB	YES	Au 0.3um MIN.		
10033853-352TB	NO NO			
10033853-252AB	YES	Au 0.76um MIN.		
10033853-352AB	NO			
10033853-452FS	YES	Au FLASH		
10033853-552FS	NO	AU FLASH		
10033853-452TS	YES	Au 0.3um MIN.	PURE Sn PLATING	
10033853-552TS	NO NO			
10033853-452AS	YES	Au 0.76um MIN.		
10033853-552AS	NO	Au O./Ouiii Willy.		Sn—Pb PLATING
10033853-452FB	YES	Au FLASH	Sn-Pb PLATING	
10033853-552FB	NO			
10033853-452TB	YES	Au 0.3um MIN.		
10033853-552TB	NO NO			
10033853-452AB	YES	Au 0.76um MIN.		
10033853-552AB	NO	Au 0./ Outil Mills.		

-For Rohs OPTIONS: TAIL PLATING CODE MUST BE 0~3. HOLD DOWN PLATING CODE MUST BE "S". 10033853-□ □□ □ □ LF "LF" CODE IS EXIST IN THE END. EX: 10033853-252TSLF <PACKING METHOD> R : TAPE REEL DEFAULT : TRAY -FOR NOT Rohs COMPATIBLE: THIS "LF" CODE IS "BLANK". EX:10033853-452TS <HOLD DOWN FINISH> S : Pure Sn B : Sn-Pb <CONTACT AREA FINISH> F : Au FLASH T: Au 0.3um MIN. A: Au 0.76um MIN. <TOTAL HEIGHT> 52: 5.2mm <LOCATING PEG, SOLDER TAIL FINISH>
0 : YES, Au FLASH
1 : NO, Au FLASH
2 : YES, Pure Sn PLATING
3 : NO, Pure Sn PLATING
4 : YES, Sn-Pb PLATING
5 : NO, Sn-Pb PLATING

mat'l. code tolerances unless FCI CUSTOMER otherwise specified COPY .X ± 0.20 Itr ecn no dr date www.fciconnect.com projection D .XX ± 0.10 linear DDR II 0.6 mm PITCH 200 POS. STANDARD TYPE ASS'Y angles 0° ±5° M.Hasegawa 6/29/'04 product family 50UF SO-DIMM code dr MM size dwg no engr M.Hasegawa 6/29/'04 JΡ scale chr sheet 10033853 2:1 appd 4 of sheet revision index sheet

1 2

ACAD

PDM: Rev:D

STATUS: Released

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